



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant:

Hisatsugu KURITA et al.

Title:

SILICON WAFER CLEANING METHOD

Appl. No.:

10/645,911

Filing Date:

08/22/2003

Examiner:

Michail Kornakov

Art Unit:

1746

Confirmation No.:

8557

## **AMENDMENT AND REPLY UNDER 37 CFR 1.116**

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

Sir:

This communication is responsive to the Final Office Action dated August 3, 2006, concerning the above-referenced patent application.

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this document.

Remarks/Arguments begin on page 3 of this document.

Please amend the application as follows:

ENPERON N/RCE 2/4/166 2/8/06